

# SEMITOP® 3

1-phase bridge rectifier+3-phase bridge inverter

### **SK 9 BGD 065 ET**

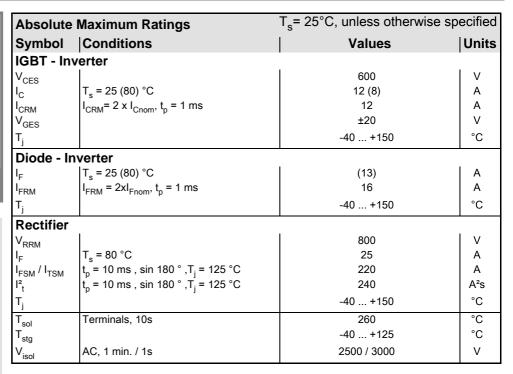
**Preliminary Data** 

#### **Features**

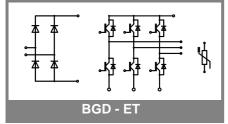
- Compact design
- · One screw mounting
- Heat transfer and isolation through direct copper bonded alumium oxide ceramic (DCB)
- N-channel homogeneous silicon structure (NPT-Non punch-through IGBT)
- · High short circuit capability
- Low tail current with low temperature dependance

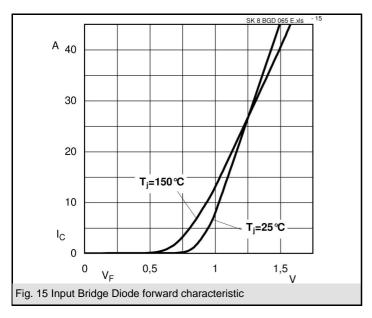
### Typical Applications\*

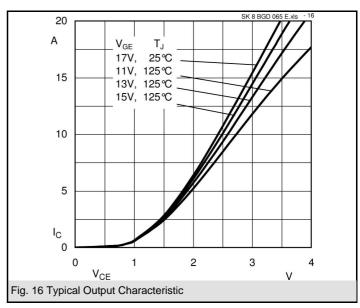
- Inverter
- · Servo drives

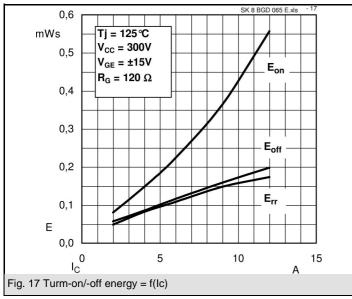


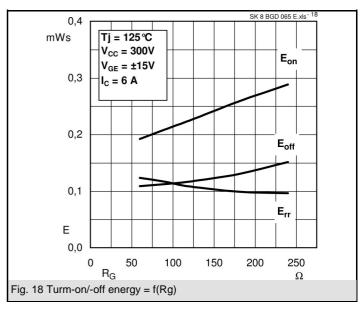
Characteristics		I <sub>s</sub> = 25°C	T <sub>s</sub> = 25°C, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units	
IGBT - In	verter	•			•	
$V_{CEsat}$	I <sub>C</sub> = 6 A, T <sub>i</sub> = 25 (125) °C		2 (2,2)		V	
$V_{GE(th)}$	$V_{GE} = V_{CE}$ , $I_C = 0.5 \text{ mA}$	3	4	5	V	
$V_{CE(TO)}$	T <sub>j</sub> = 25 °C (125) °C		1,2 (1,1)		V	
$r_T$	T <sub>j</sub> = 25 °C (125) °C		133 (183)		mΩ	
C <sub>ies</sub>	$V_{CE} = V_{GE} = 0 \text{ V, f} = 1 \text{ MHz}$		-		nF	
C <sub>oes</sub>	$V_{CE} = V_{GE} = 0 \text{ V, } f = 1 \text{ MHz}$		-		nF	
C <sub>res</sub>	$V_{CE} = 25 V_{GE} = 0 V, f = 1 MHz$		0,03		nF	
R <sub>th(j-s)</sub>	per IGBT			2,6	K/W	
t <sub>d(on)</sub>	under following conditions		20		ns	
$t_r$	$V_{CC} = 300 \text{ V}, V_{GE} = \pm 15 \text{ V}$		25		ns	
$t_{d(off)}$	$I_C = 6 \text{ A}, T_j = 125 °C$		145		ns	
$t_{f}$	$R_{Gon} = R_{Goff} = 120 \Omega$		25		ns	
E <sub>on</sub>	inductive load		0,22		mJ	
E <sub>off</sub>			0,12		mJ	
Diode - I	nverter					
$V_F = V_{EC}$	I <sub>F</sub> = 8 A, T <sub>j</sub> = 25(125) °C		1,35		V	
$V_{(TO)}$	$T_j = {^{\circ}C} (125) {^{\circ}C}$		(8,0)	(0,9)	V	
$r_T$	T <sub>j</sub> = °C (125) °C		(44)		mΩ	
$R_{th(j-s)}$	per diode			2,7	K/W	
I <sub>RRM</sub>	under following conditions		4,2		Α	
$Q_{rr}$	$I_F = 8 \text{ A}, V_R = 300 \text{ V}$		0,65		μC	
E <sub>rr</sub>	$V_{GE} = 0 \text{ V}, T_j = 125 ^{\circ}\text{C}$				mJ	
	$di_{F/dt} = -120 \text{ A/}\mu\text{s}$					
Diode re	ctifier					
$V_{F}$	$I_F = 20 \text{ A}, T_j = 25() \text{ °C}$		1,1		V	
$V_{(TO)}$	T <sub>i</sub> = 150 °C		0,85		V	
r <sub>T</sub>	T <sub>j</sub> = 150 °C		15		mΩ	
$R_{th(j-s)}$	per diode			2,15	K/W	
	tur sensor				•	
R <sub>ts</sub>	%, T <sub>r</sub> = ( ) °C		()		Ω	
Mechani	cal data	1			•	
w		1	31		g	
$M_s$	Mounting torque	2,3		2,5	Nm	

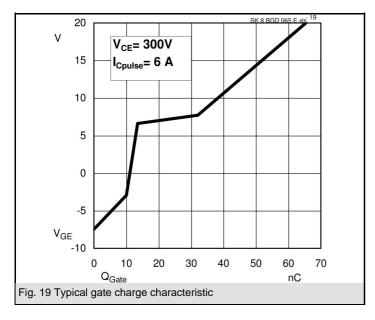


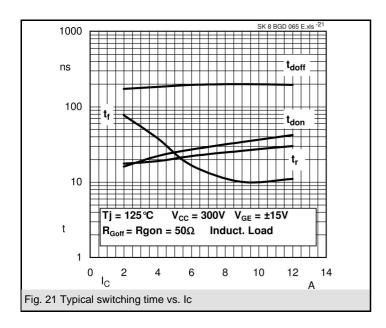


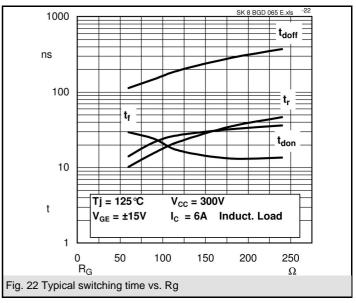


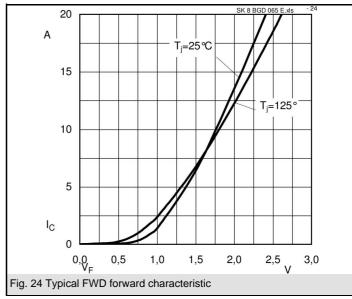




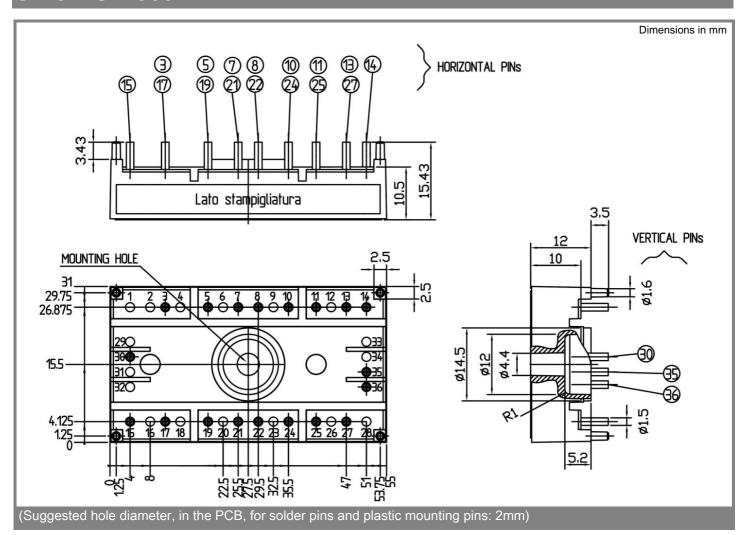


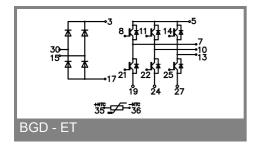






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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.

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